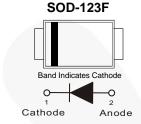


August 2015

SS13FL / SS14FL Surface Mount Schottky Barrier Rectifier

Features

- Ultra Thin Profile Maximum Height of 1.08 mm
- UL Flammability 94V-0 Classification
- MSL 1
- · RoHS Compliant / Green Mold Compound
- Industrial Device Qualified per AEC-Q101 Standards.
 - * see authorized use policy



Ordering Information

| Part Number | Top Mark | Package | Packing Method |
|-------------|----------|----------|----------------|
| SS13FL | G3 | SOD-123F | Tape and Reel |
| SS14FL | G4 | SOD-123F | Tape and Reel |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25$ °C unless otherwise noted.

| Symbol | Parameter | Va | Unit | |
|--------------------|---|--------|--------|------|
| Symbol | Farameter | SS13FL | SS14FL | Unit |
| V _{RRM} | / _{RRM} Peak Reverse Voltage | | 40 | V |
| V _R | Reverse Voltage | 30 | 40 | V |
| I _{F(AV)} | Average Rectified Current at T _A = 75°C | 1.0 | | Α |
| I _{FSM} | Non-Repetitive Peak Forward Surge Current at t = 8.3 ms | 40 | | Α |
| TJ | Operating Junction Temperature Range -55 to +125 | | +125 | °C |
| T _{STG} | Storage Temperature Range | -55 to | °C | |

Thermal Characteristics(1)

Values are at $T_A = 25$ °C unless otherwise noted.

| Symbol | Parameter | Value | Unit |
|-----------------|--|-------|------|
| ΨJL | Typical Thermal Characteristics, Junction-to-Lead ⁽²⁾ | 25 | °C/W |
| $R_{\theta JA}$ | Typical Thermal Resistance, Junction-to-Ambient | 140 | °C/W |

Note:

- 1. Per JESD51-3 recommended thermal test board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.
- 2. Thermocouple soldered at cathode lead.

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

| Symbol | Parameter | Condition | s | Min. | Тур. | Max. | Unit |
|-----------------|---------------------------|---|--------|------|-------|------|------|
| BV _R | Reverse Breakdown Voltage | I _R = 500 μA | SS13FL | 30 | | | - V |
| ΒVR | | | SS14FL | 40 | | | |
| V _F | Forward Voltage | I _F = 1.0 A | | | | 0.55 | V |
| I _R | Reverse Leakage Current | $V_R = V_{RRM}$ | | | | 30 | μΑ |
| т | Reverse Recovery Time | I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A | SS13FL | | 5.875 | | - ns |
| T_{rr} | | | SS14FL | | 5.695 | | |
| CJ | Junction Capacitance | V _R = 0 | | | 60 | | pF |

Typical Performance Characteristics

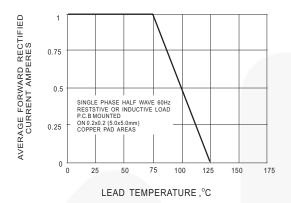


Figure 1. Forward Current Derating Curve

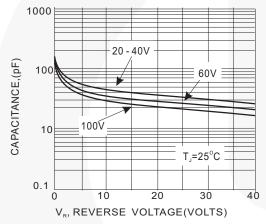


Figure 3. Typical Junction Characteristic

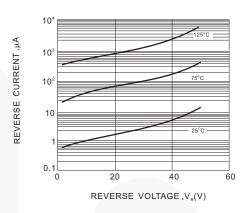
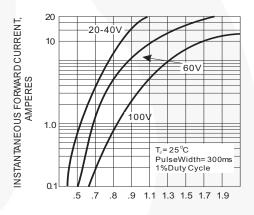


Figure 2. Typical Reverse Characteristic



INSTANTANEOUS FORWARD VOLTAGE, VOLTS

Figure 4. Typical Instantaneous Forward Characteristics

Physical Dimensions 1.95 1.50 2.86 3.90 1.80 3.00 3.30 2.50 (0.35) 1.15 0.50 LAND PATTERN RECOMMENDATION 4°-10° 0.20 1.08 0.80 0.05 +/-0.10 A NOTES: A. THIS PACKAGE DOES NOT CONFORM TO ANY STANDARDS. B. ALL DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS. D. DRAWING FILE NAME: MA02BREV5 FAIRCHILD , Figure 5. 2-LEAD, SOD123F, NON-JEDEC, FLAT TERMINAL





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| Definition of Terms | | | | | |
|--------------------------|-----------------------|---|--|--|--|
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